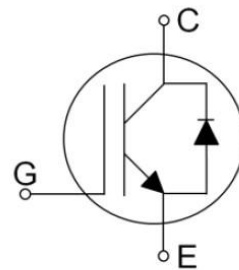


FEATURES

- High breakdown voltage to 1200V for improved reliability
- Trench-Stop Technology offering :
 - High speed switching
 - High ruggedness, temperature stable
 - Low V_{CEsat}
 - Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}

V_{CE}	1200	V
I_C	75	A
$V_{CE(SAT)} I_C=75A$	1.7	V



APPLICATION

- Uninterruptible Power Supplies
- Solar inverter
- Welding
- PFC applications

Product	Package	Packaging
YGQ75N120FP	TO247-PLUS	Tube

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	1200	V
DC collector current, limited by T_{jmax} $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_C	150 75	A
Diode Forward current, limited by T_{jmax} $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	I_F	150 75	A
Continuous Gate-emitter voltage	V_{GE}	± 20	V
Transient Gate-emitter voltage	V_{GE}	± 30	V
Turn off safe operating area $V_{CE} \leq 1200\text{V}$, $T_j \leq 150^\circ\text{C}$	-	300	A
Pulsed Collector Current, $V_{GE} = 15\text{V}$, t_p limited by T_{jmax}	I_{CM}	300	A
Diode Pulsed Current, t_p limited by T_{jmax}	I_{Fpuls}	300	A
Power dissipation , $T_j = 25^\circ\text{C}$	P_{tot}	735	W
Max. Junction Temperature (Under switching conditions)	T_{jmax}	150	$^\circ\text{C}$
Operating junction temperature	T_{Jop}	-40...+150	$^\circ\text{C}$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s	-	260	$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT thermal resistance, junction - case	$R_{\theta(j-c)}$	0.17	K/W
Diode thermal resistance, junction - case	$R_{\theta(j-c)}$	0.35	K/W
Thermal resistance, junction - ambient	$R_{\theta(j-a)}$	40	K/W

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified) :

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter breakdown voltage	BV_{CES} ①	$V_{GE}=0V, I_C=250\mu A$	1200	1300	-	V
Gate threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=250\mu A$	-	5.1	-	V
Collector-Emitter Saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=75A$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	1.62 1.94	-	V
Zero gate voltage collector current	I_{CES}	$V_{CE} = 1200V, V_{GE} = 0V$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	- -	250 2500	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0V, V_{GE} = \pm 20V$	-	-	100	nA
Transconductance	g_{fs}	$V_{CE}=20V, I_C=75A$	-	67	-	S

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input capacitance	C_{ies}	$V_{CE} = 25V, V_{GE} = 0V,$ $f = 1\text{MHz}$	-	7655	-	pF
Output capacitance	C_{oes}		-	351	-	
Reverse transfer capacitance	C_{res}		-	39.26	-	
Gate charge	Q_G	$V_{CC} = 960V, I_C = 75A,$ $V_{GE} = 15V$	-	233.1	-	nC

Note:

 ① BV_{ces} testing without filter could damage the device. BV_{ces} is guaranteed by $I_{ces}@1200V$ test.

Switching Characteristic, Inductive Load

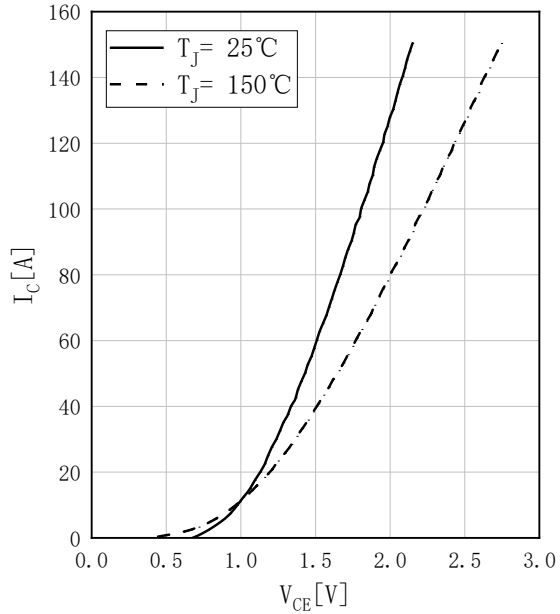
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at $T_j = 25^\circ \text{C}$						
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 600\text{V}, I_C = 75\text{A},$ $V_{GE} = \pm 15\text{V},$ $R_g = 6.6\Omega$	-	122	-	ns
Rise time	t_r		-	89	-	ns
Turn-on energy	E_{on}		-	6.6	-	mJ
Turn-off delay time	$t_{d(off)}$		-	171	-	ns
Fall time	t_f		-	53	-	ns
Turn-off energy	E_{off}		-	2.9	-	mJ

Electrical Characteristics of the DIODE ($T_j = 25^\circ \text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Diode Forward Voltage	V_{FM}	$I_F = 75\text{A}$	-	2.0	-	V
Reverse Recovery Time	T_{rr}	$I_F = 75\text{A},$ $V_R = 600\text{V},$ $di/dt = 600\text{A}/\mu\text{s},$	-	298	-	ns
Reverse Recovery Current	I_{rr}		-	26.6	-	A
Reverse Recovery Charge	Q_{rr}		-	4.34	-	nC

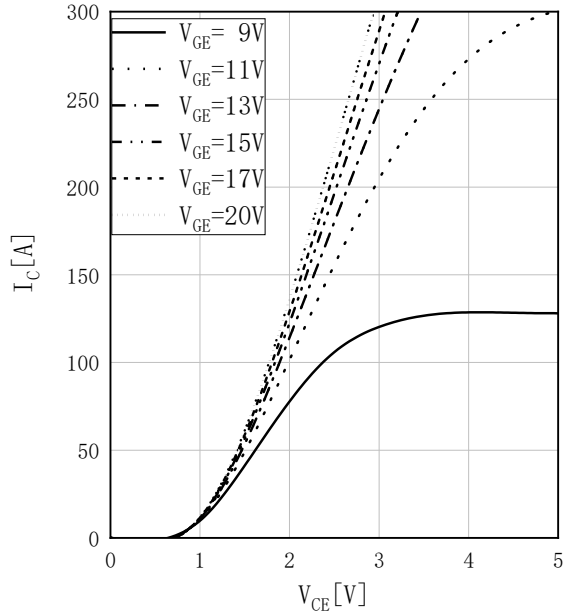
Saturation voltage characteristics

$I_C=f(V_{CE})$
 $V_{GE}=15V$



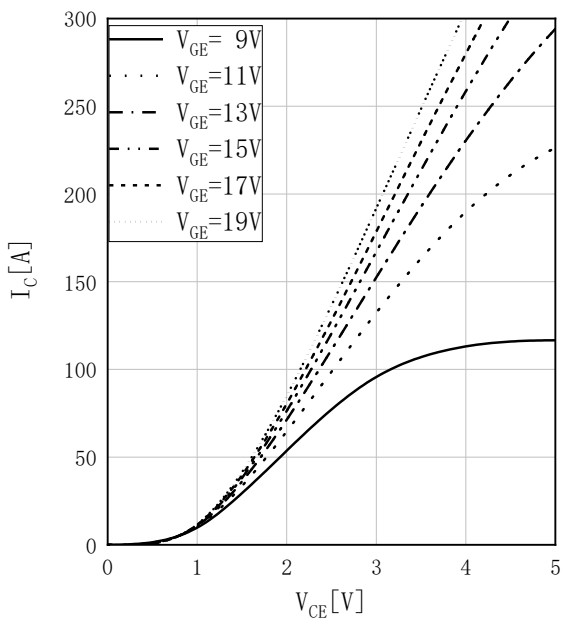
Output characteristics

$I_C=f(V_{CE})$
 $T_1=25^\circ C$



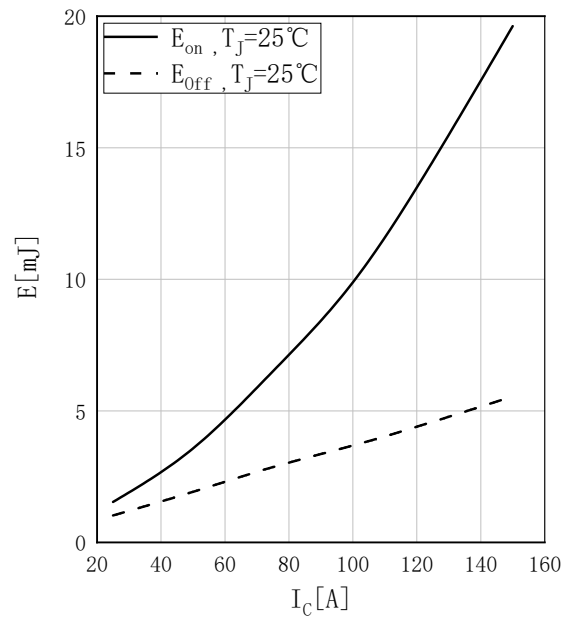
Output characteristics

$I_C=f(V_{CE})$
 $T_1=150^\circ C$



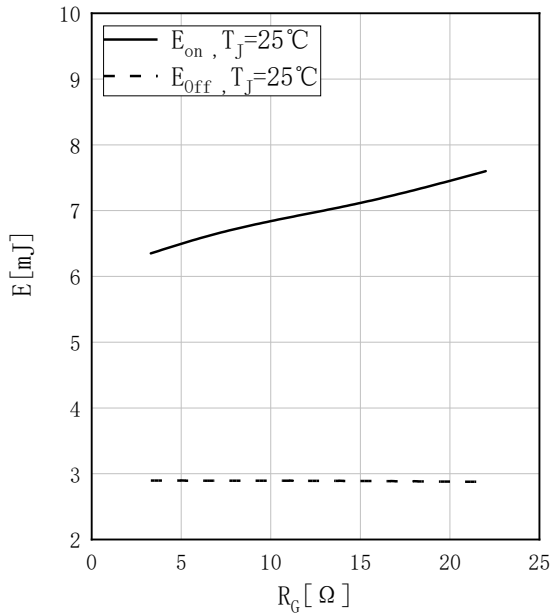
Switching losses IGBT

$E_{on}=f(I_C), E_{off}=f(I_C)$
 $V_{GE}=\pm 15V, R_G=6.6\Omega, V_{CE}=600V$



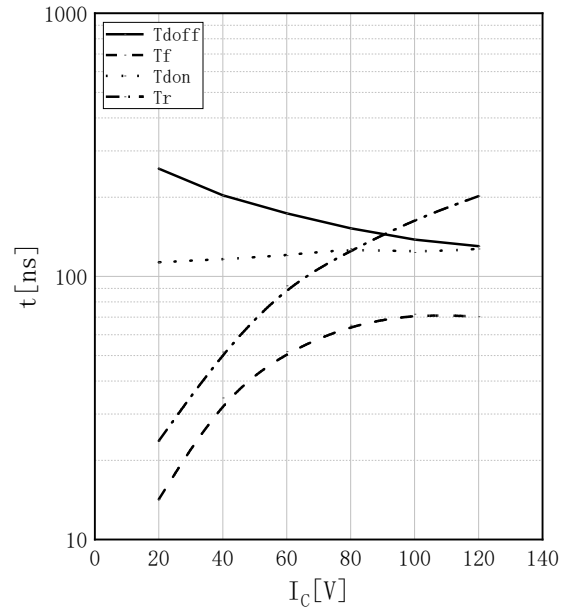
Switching losses IGBT

$E_{on}=f(R_G), E_{off}=f(R_G)$
 $V_{GE}=\pm 15V, I_C=75A, V_{CE}=600V$



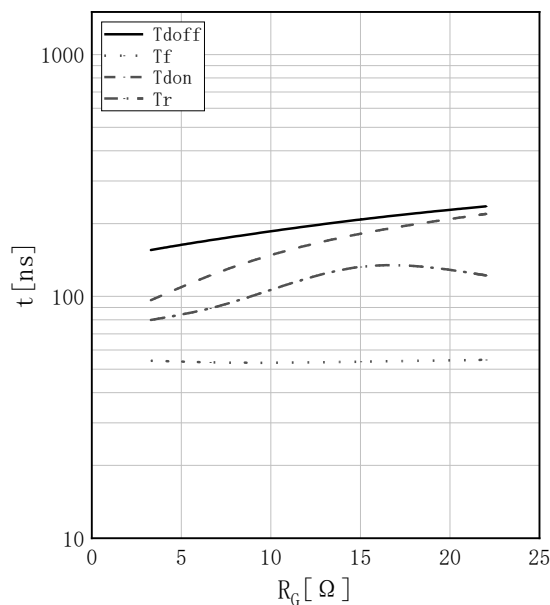
Switching times IGBT

$T_{don}=f(I_C), T_r=f(I_C), T_{doff}=f(I_C), T_f=f(I_C)$
 $V_{GE}=\pm 15V, R_G=6.6\Omega, V_{CE}=600V, T_1=25^\circ C$



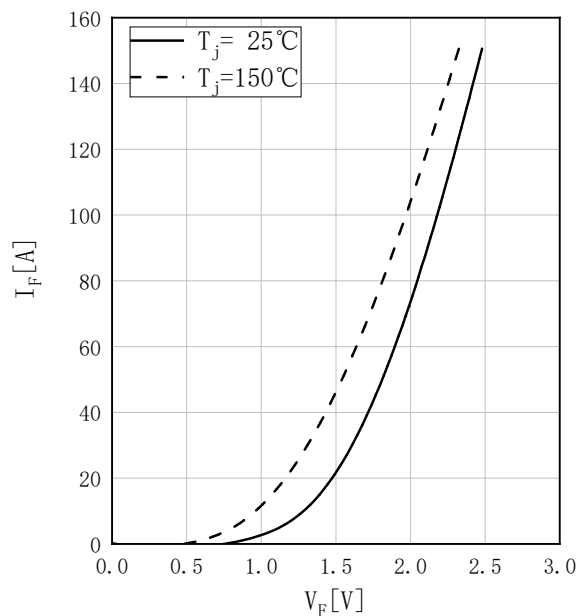
Switching times IGBT

$T_{don}=f(R_G), T_r=f(R_G), T_{doff}=f(R_G), T_f=f(R_G)$
 $V_{GE}=\pm 15V, I_C=75A, V_{CE}=600V, T_1=25^\circ C$



Forward characteristic of Diode

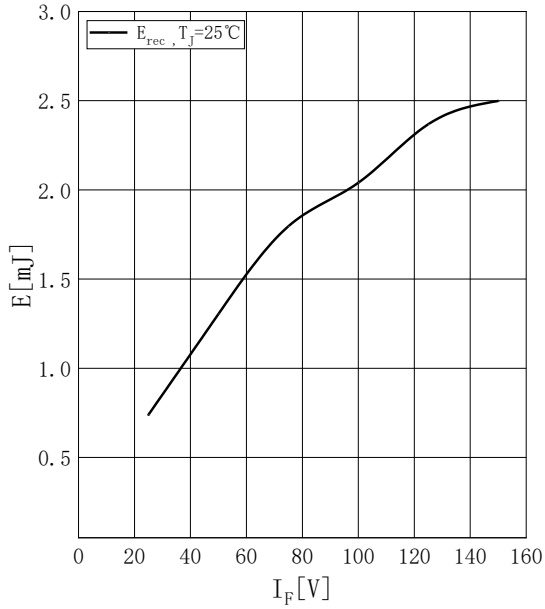
$I_F=f(V_F)$



Switching losses Diode

$$E_{rec}=f(I_F)$$

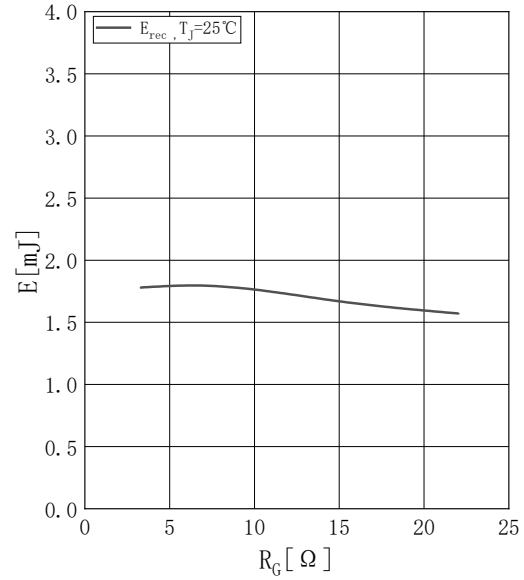
$$R_{Gon}=6.6\Omega, V_{CE}=600V$$



Switching losses Diode

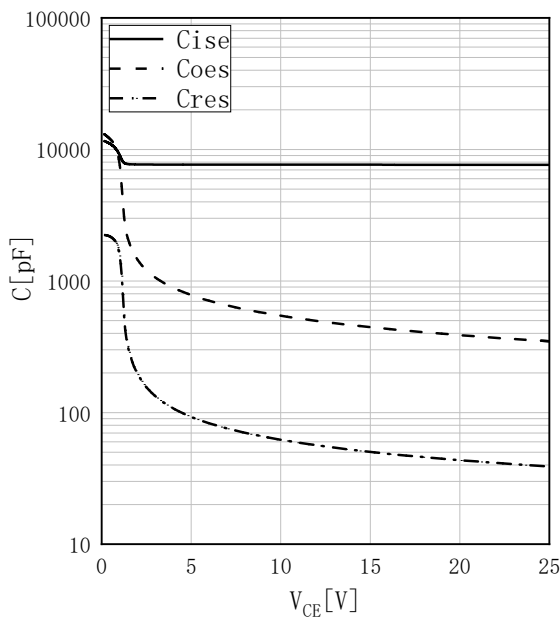
$$E_{rec}=f(R_G)$$

$$I_F=75A, V_{CE}=600V$$

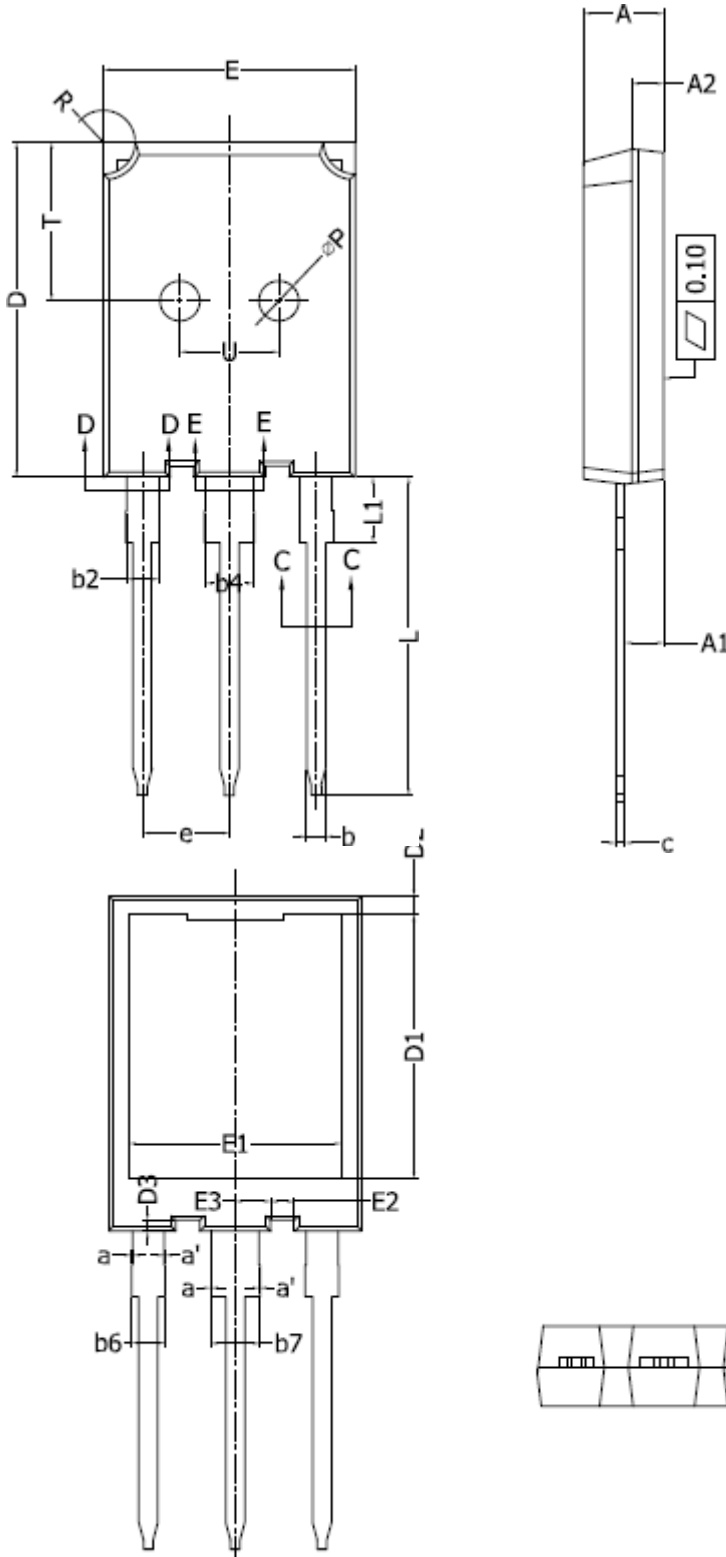


Capacitance characteristics

$$C_{ies}=f(V_{CE}), C_{oes}=f(V_{CE}), C_{res}=f(V_{CE})$$

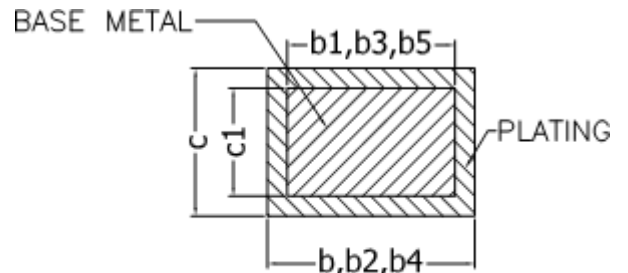


TO247-PLUS package information



COMMON DIMENSIONS
(UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0	—	0.15
a'	0	—	0.15
b	1.16	—	1.26
b1	1.15	1.2	1.22
b2	1.96	—	2.06
b3	1.95	2.00	2.02
b4	2.96	—	3.06
b5	2.96	3.00	3.02
b6	—	—	2.25
b7	—	—	3.25
c	0.59	—	0.66
c1	0.59	0.60	0.66
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
D3	0.58	—	0.78
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	1.40	1.50	1.60
E3	2.12	2.22	2.32
e	5,436 BSC		
L	19.80	19.95	20.10
L1	—	—	4.30
P	2.40	2.50	2.60
R	1.90	—	2.10
T	9.80	—	10.20
U	6.00	—	6.40



SECTION C-C, D-D & E-E